

4.2 Board Layout

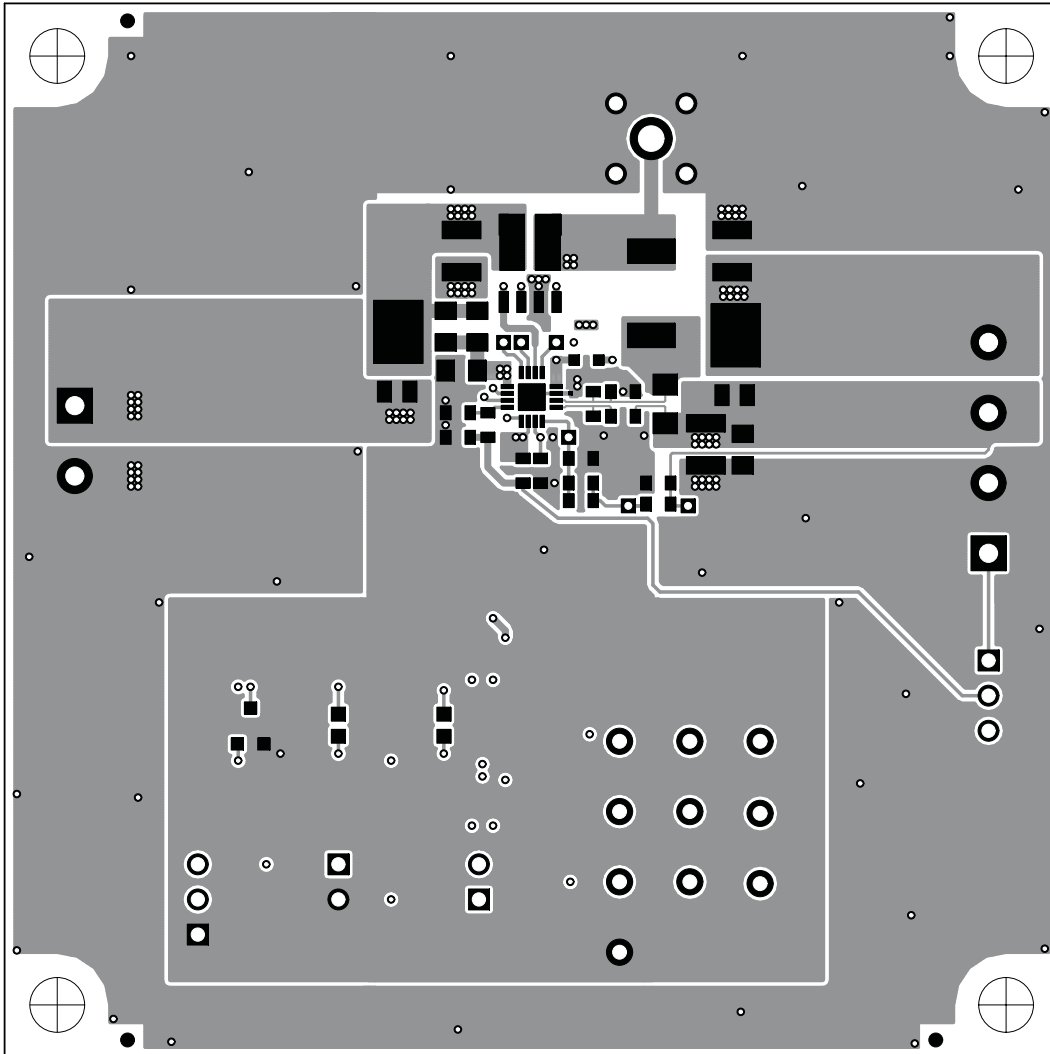


Figure 2. Top Layer

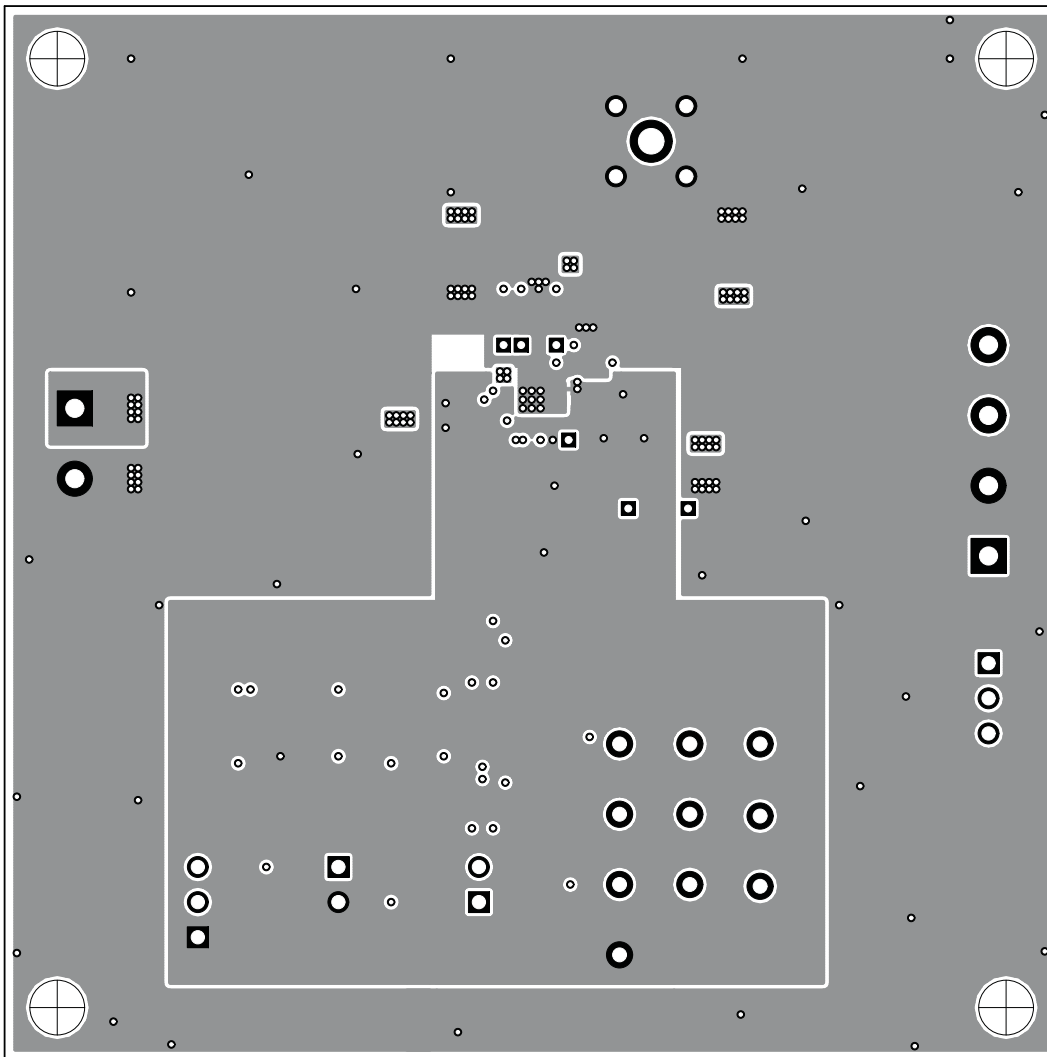


Figure 3. Second Layer

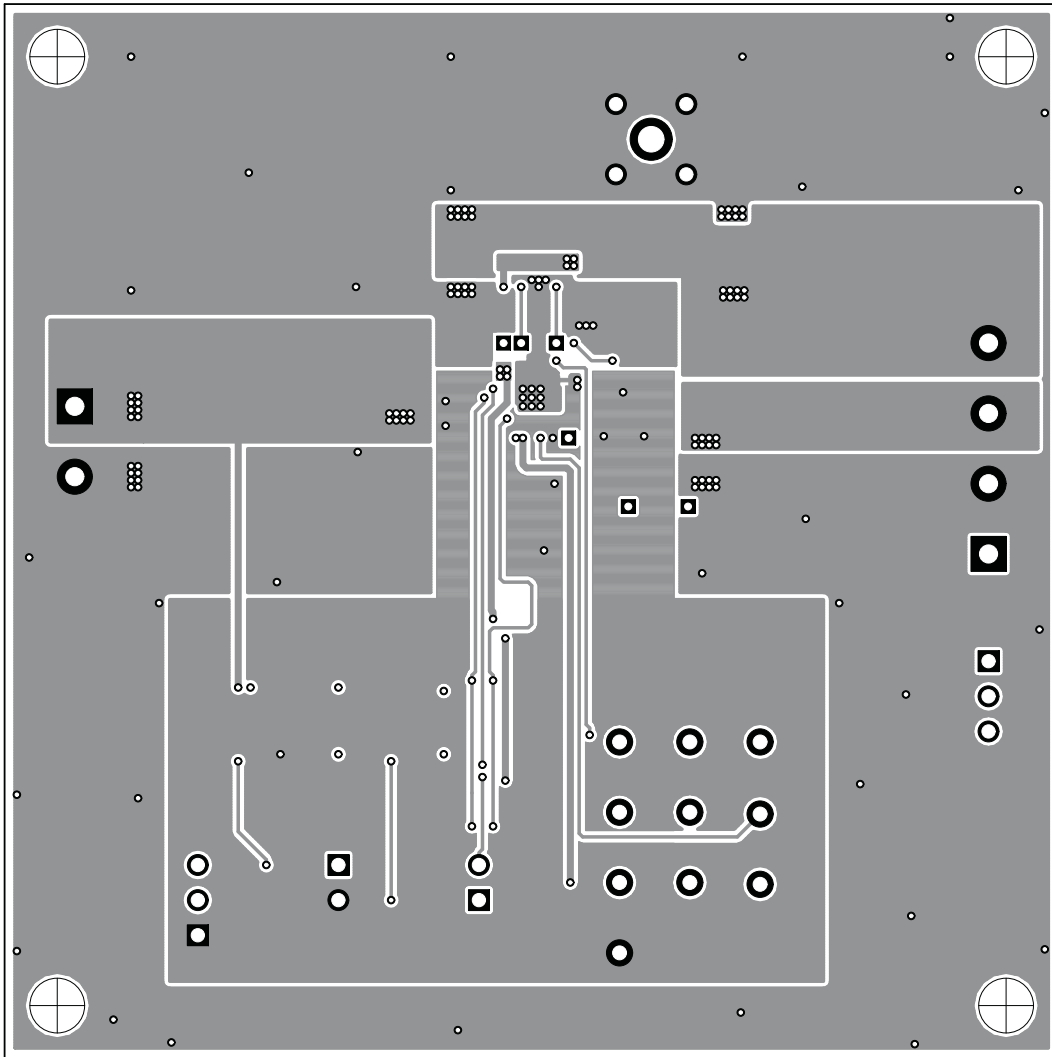


Figure 4. Third Layer

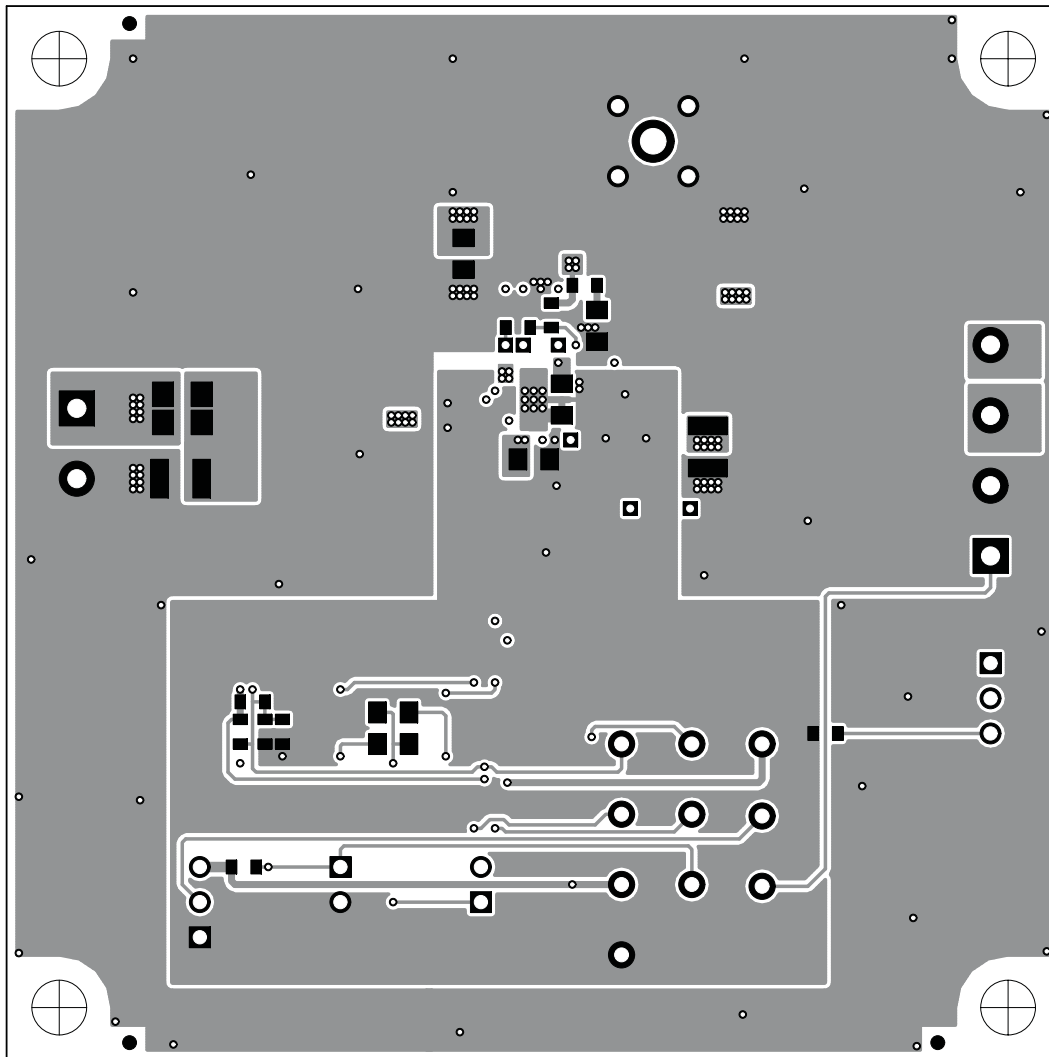


Figure 5. Bottom Layer

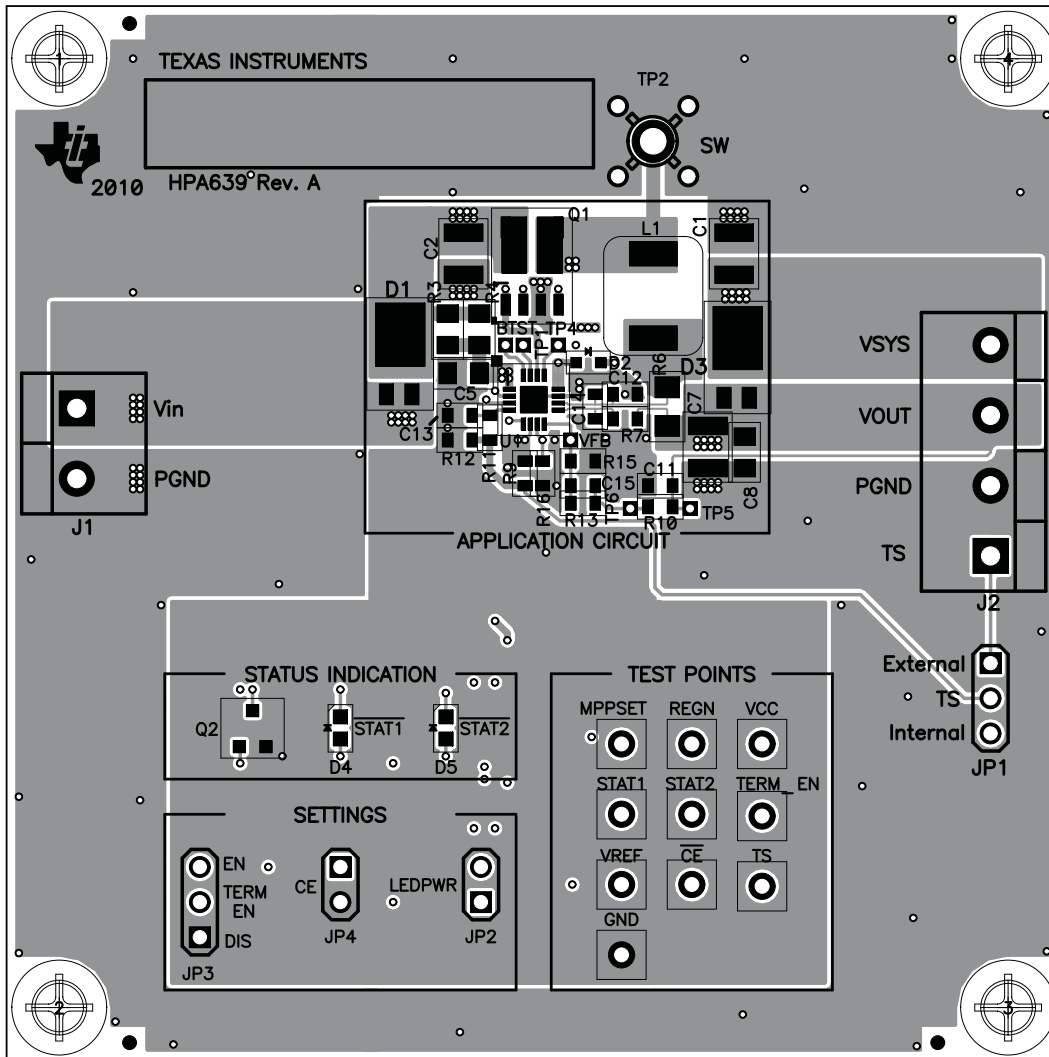


Figure 6. Top Assembly

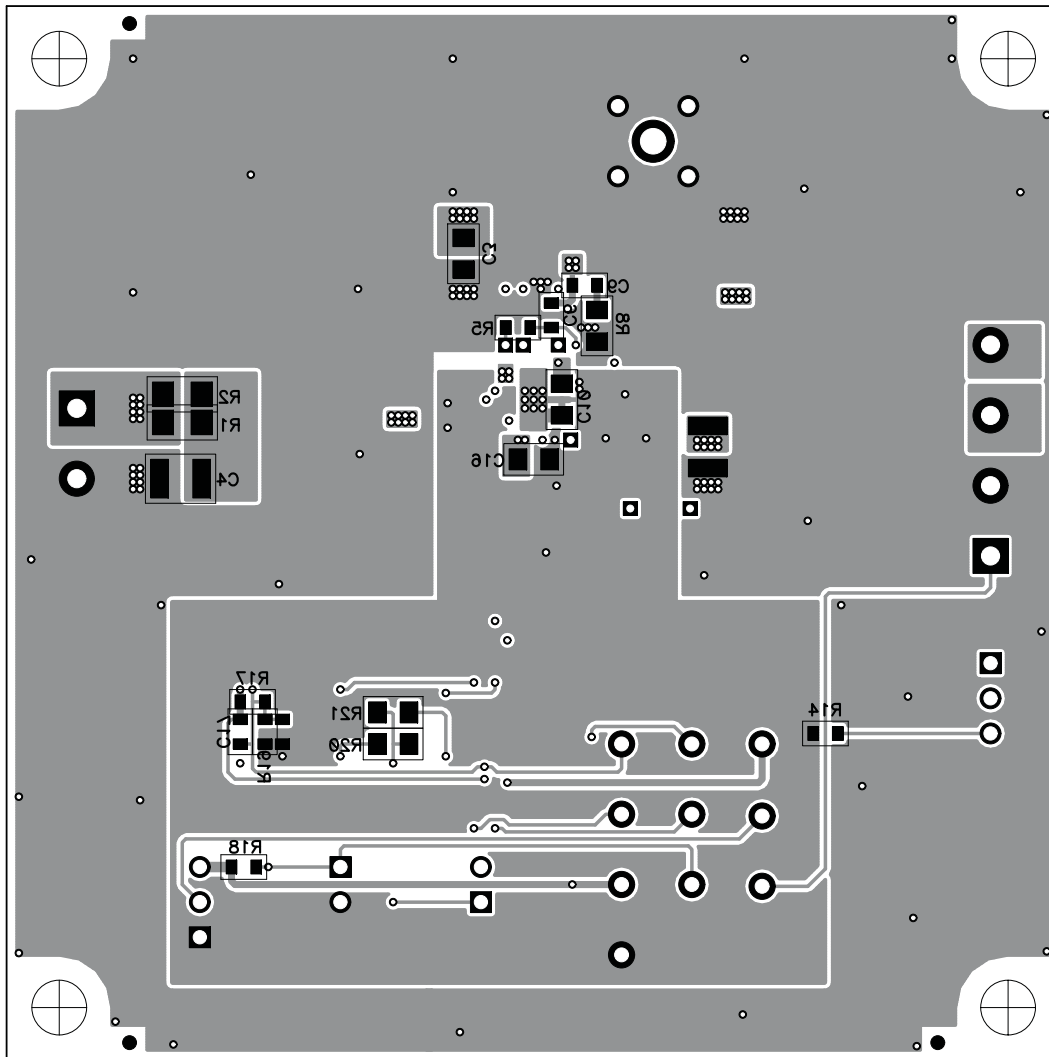


Figure 7. Bottom Assembly

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